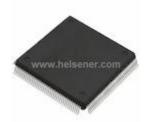




MC68376BGCAB25 Information



For Reference Only

Part Number MC68376BGCAB25

Manufacturer NXP

Category Integrated Circuits (ICs)

Embedded - Microcontrollers

Description IC MCU 32BIT ROMLESS 160QFP

Package 160-BQFP

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









MC68376BGCAB25 Specifications

Manufacturer Part Number	MC68376BGCAB25
Manufacturer	NXP
Category	Integrated Circuits (ICs)
	Embedded - Microcontrollers
Package	160-BQFP
Series	M683xx
Core Processor	CPU32
Core Size	32-Bit
Speed	25MHz
Connectivity	CAN, EBI/EMI, SCI, SPI
Peripherals	POR, PWM, WDT
Number of I/O	18
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	7.5K x 8
Voltage - Supply (Vcc/Vdd)	4.75 V ~ 5.25 V
Data Converters	A/D 16x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	160-BQFP
Supplier Device Package	160-QFP (28x28)
	Report errors?

MC68376BGCAB25 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MC68376BGCAB25 Payment Methods





















MC68376BGCAB25 Shipping Methods













If you have any question about MC68376BGCAB25, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com